Ignition IGBT 18 Amps, 450 Volts

N-Channel DPAK

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over–Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

Features

- Ideal for Coil-on-Plug Applications
- DPAK Package Offers Smaller Footprint for Increased Board Space
- Gate-Emitter ESD Protection
- Temperature Compensated Gate–Collector Voltage Clamp Limits Stress Applied to Load
- Low Threshold Voltage Interfaces Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- Emitter Ballasting for Short-Circuit Capability
- This is a Pb–Free Device

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

× -	;		
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CES}	500	V_{DC}
Collector-Gate Voltage	V _{CER}	500	V_{DC}
Gate-Emitter Voltage	V_{GE}	18	V_{DC}
Collector Current–Continuous @ T _C = 25°C – Pulsed	Ι _C	18 50	A _{DC} A _{AC}
ESD (Human Body Model) R = 1500 Ω , C = 100 pF	ESD	8.0	kV
ESD (Machine Model) R = 0 Ω , C = 200 pF	ESD	400	V
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	115 0.77	Watts W/°C
Operating and Storage Temperature Range	T _J , T _{stg}	–55 to +175	°C

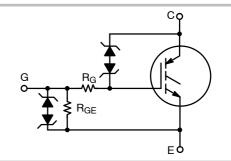
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

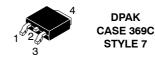


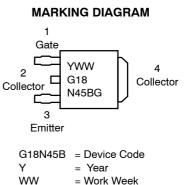
ON Semiconductor®

http://onsemi.com

18 AMPS 450 VOLTS V_{CE(on)} ≤ 2.1 V @ I_C = 10 A, V_{GE} ≥ 4.5 V







_	110110 110	ON
=	Pb-Free	Device

ORDERING INFORMATION

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Device	Package	Shipping [†]
NGD18N45CLBT4G	DPAK (Pb-Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS (Note 2)

Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds

Characteristic		Symbol	Value	Unit
	E _{AS}	338 420 237 247	mJ	
AXIMUM SHORT-CIRCUIT TIMES				
Short Circuit Withstand Time – Test 1 (See Figure 17, 3 Pulses with 10 ms Period, T _a = 105°C	C)	t _{sc1-1}	1000	μS
Short Circuit Withstand Time – Test 1 (See Figure 17, 3 Pulses with 10 ms Period, T _a = 150°C	t _{sc1-2}	800	μS	
Short Circuit Withstand Time – Test 2 (See Figure 18, 3 Pulses with 10 ms Period, T _a = 105°C)		t _{sc2-1}	5	ms
Short Circuit Withstand Time – Test 2 (See Figure 18, 3 Pulses with 10 ms Period, T _a = 150°C	t _{sc2-2}	1	ms	
HERMAL CHARACTERISTICS		-	-	-
Thermal Resistance, Junction to Case		$R_{ extsf{ heta}JC}$	1.3	°C/W
Thermal Resistance, Junction to Ambient	DPAK (Note 1)	R _{θJA}	95	°C/W

275

ΤL

°C

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Тур	Мах	Unit
OFF CHARACTERISTICS (Note 2)							
Collector-Emitter Clamp Voltage	BV _{CES}	I _C = 2.0 mA	$T_J = -40^{\circ}C$ to 150°C	430	455	470	V _{DC}
		l _C = 10 mA	$T_J = -40^{\circ}C$ to 150°C	440	475	500	
Zero Gate Voltage Collector Current	I _{CES}		$T_J = 25^{\circ}C$	_	0.5	20	μA _{DC}
		V _{CE} = 350 V, V _{GE} = 0 V	$T_{\rm J} = 150^{\circ}{\rm C}$	-	75	250	
		VGE - V V	$T_J = -40^{\circ}C$	-	0.2	10	
		V _{CE} = 15 V, V _{GE} = 0 V	T _J = 25°C	-	-	2.0	
Reverse Collector-Emitter Leakage Current	I _{ECS}		$T_{\rm J} = 25^{\circ}C$	-	0.7	1.0	mA
		$V_{CE} = -24 V$	$T_{\rm J} = 150^{\circ}{\rm C}$	-	12	25	
			$T_J = -40^{\circ}C$	-	0.1	1.0	
Reverse Collector-Emitter Clamp Voltage	B _{VCES(R)}		$T_J = 25^{\circ}C$	24	27	30	V _{DC}
		I _C = -75 mA	$T_{\rm J} = 150^{\circ} C$	26	29	33	
			$T_J = -40^{\circ}C$	23	26	29	
Gate-Emitter Clamp Voltage	BV _{GES}	I _G = 5.0 mA	$T_{J} = -40^{\circ}C \text{ to}$ $150^{\circ}C$	11	13	15	V _{DC}
Gate-Emitter Leakage Current	I _{GES}	V _{GE} = 10 V	T _J = −40°C to 150°C	384	590	700	μA _{DC}
Gate Resistor	R _G	-	$T_J = -40^{\circ}C$ to 150°C	-	70	-	Ω
Gate Emitter Resistor	R _{GE}	-	$T_J = -40^{\circ}C$ to 150°C	10	16	26	kΩ

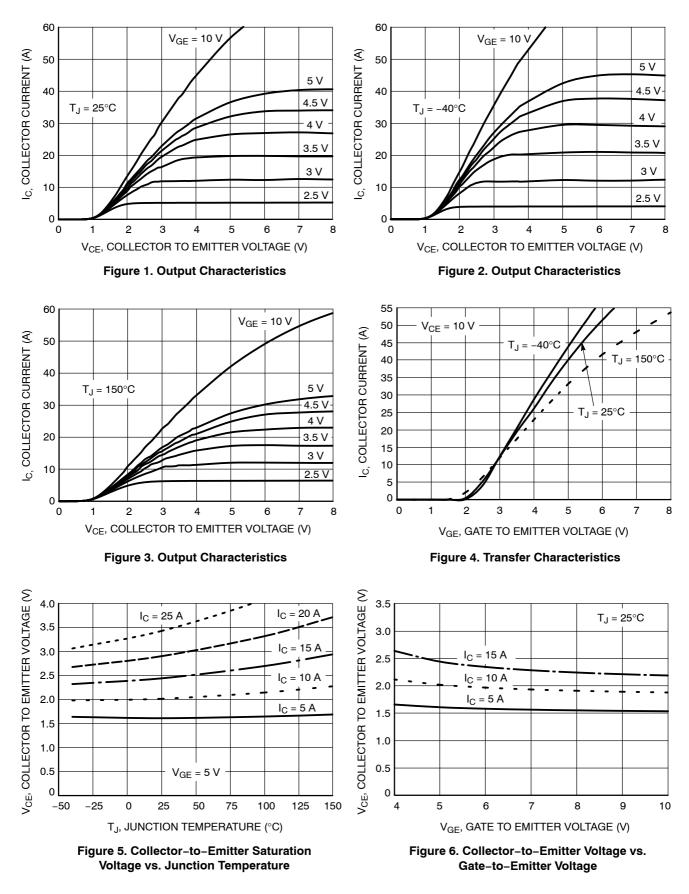
1. When surface mounted to an FR4 board using the minimum recommended pad size.

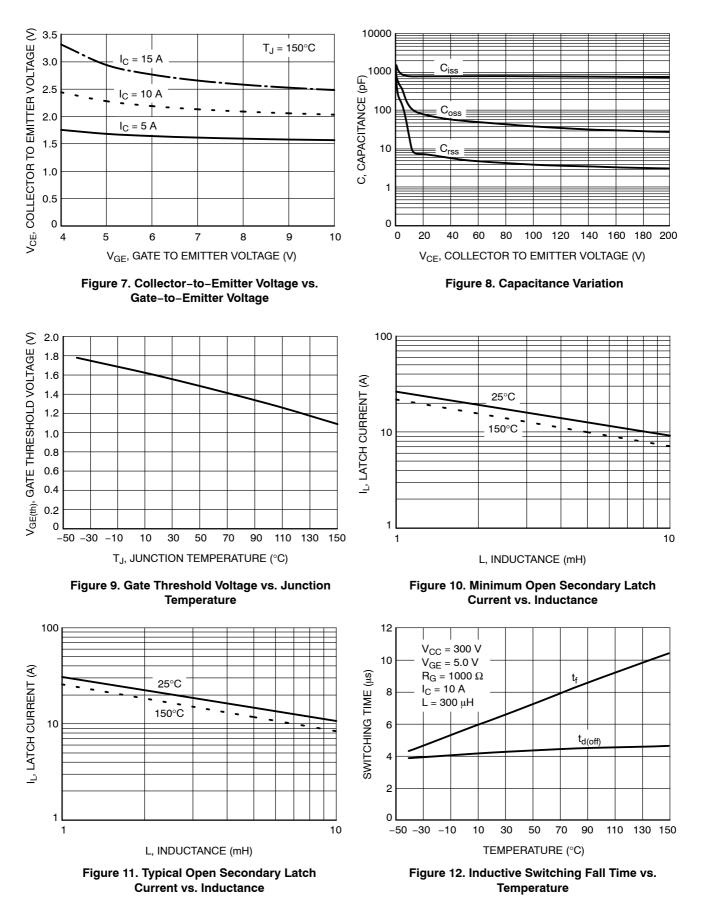
ELECTRICAL CHARACTERISTICS (continued)

Characteristic	Symbol	Test Conditions	Temperature	Min	Тур	Max	Unit
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GE(th)}		$T_J = 25^{\circ}C$	1.1	1.56	1.9	V _{DC}
		I _C = 1.0 mA, V _{GE} = V _{CE}	T _J = 150°C	0.75	1.08	1.4	
		VGE – VCE	$T_J = -40^{\circ}C$	1.2	1.75	2.1	
Collector-to-Emitter On-Voltage	V _{CE(on)}	I _C = 7 A, V _{GE} = 4.5 V	T _J = -40°C to 150°C	1.10	1.84	2.30	V
		I _C = 7 A, V _{GE} = 4.0 V	T _J = -40°C to 150°C	1.15	1.89	2.35	
		I _C = 7 A, V _{GE} = 3.7 V	T _J = -40°C to 150°C	1.20	1.93	2.50	
		I _C = 10 A, V _{GE} = 4.5 V	T _J = -40°C to 150°C	1.45	2.07	2.65	
		I _C = 10 A, V _{GE} = 4.0 V	T _J = −40°C to 150°C	1.50	2.13	2.80	
		I _C = 10 A, V _{GE} = 3.7 V	T _J = −40°C to 150°C	1.55	2.19	2.85	
		I _C = 10 mA, V _{GE} = 4.5 V	T _J = -40°C to 150°C	-	0.65	1.00	
Threshold Temperature Coefficient (Negative)	-	-	-	-	3.5	-	mV/°C
Forward Transconductance	gfs	V_{CE} = 5.0 V, I _C = 6.0 A	$T_J = -40^{\circ}C$ to 150°C	6.0	14	25	Mhos
DYNAMIC CHARACTERISTICS (Note 2)				-	-		
Input Capacitance	C _{ISS}			400	780	1000	pF
Output Capacitance	C _{OSS}	V _{CC} = 25 V, V _{GE} = 0 V f = 1.0 MHz	T _J = -40°C to 150°C	50	72	100	
Transfer Capacitance	C _{RSS}	1 - 1.0 WHZ	100 0	4.0	6	10	
WITCHING CHARACTERISTICS (Note	2)			-	-		
Turn-Off Delay Time	t _{d(off)}		$T_J = 25^{\circ}C$	1.0	2.9	12	μSec
Fall Time	t _f	$\label{eq:V_CC} \begin{array}{l} {\sf V}_{CC} = 300 \; {\sf V}, {\sf V}_{GE} = 5 \; {\sf V} \\ {\sf R}_{G} = 1.0 \; {\sf k}\Omega, {\sf R}_{L} = 46 \; \Omega, \end{array}$	T _J = 25°C	1.0	2.5	7.0	
Turn-On Delay Time	t _{d(on)}	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 14 \; V, V_{GE} = 5 \; V \\ R_{G} = 1.0 \; k\Omega, R_{L} = 1 \; \Omega \end{array}$	T _J = 25°C	0.1	0.42	1.4	μSec
Rise Time	t _r	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 14 \; V, \; V_{GE} = 5 \; V \\ R_{G} = 1.0 \; k\Omega, \; R_{L} = 1 \; \Omega \end{array}$	T _J = 25°C	1.0	2.5	9.0	

2. Electrical Characteristics at temperature other than 25°C, Dynamic and Switching characteristics are not subject to production testing.

TYPICAL ELECTRICAL CHARACTERISTICS (unless otherwise noted)





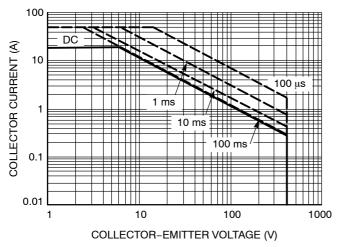


Figure 13. Single Pulse Safe Operating Area (Mounted on an Infinite Heatsink at $T_A = 25^{\circ}C$)

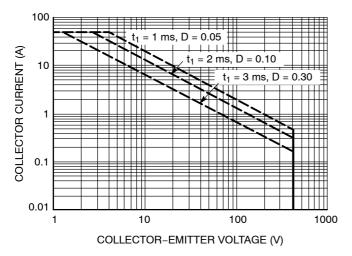
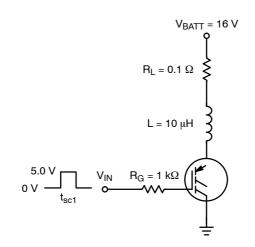
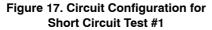


Figure 15. Pulse Train Safe Operating Area (Mounted on an Infinite Heatsink at $T_C = 25^{\circ}C$)





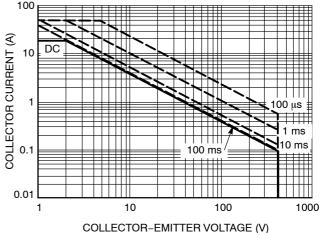


Figure 14. Single Pulse Safe Operating Area (Mounted on an Infinite Heatsink at $T_A = 125^{\circ}C$)

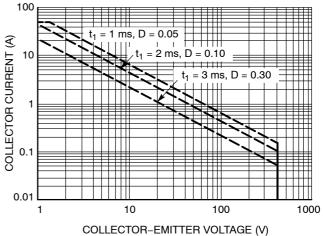


Figure 16. Pulse Train Safe Operating Area (Mounted on an Infinite Heatsink at $T_C = 125^{\circ}C$)

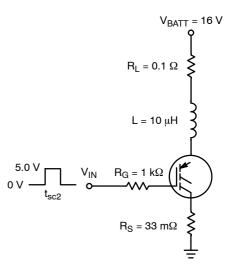


Figure 18. Circuit Configuration for Short Circuit Test #2

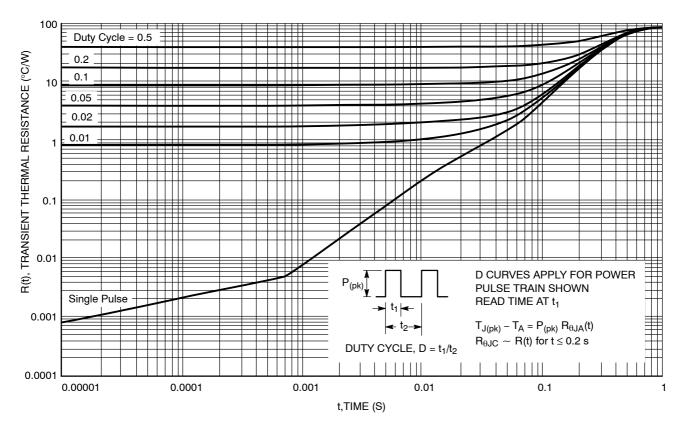
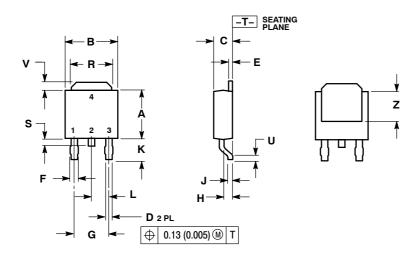


Figure 19. Transient Thermal Resistance (Non-normalized Junction-to-Ambient mounted on minimum pad area)

PACKAGE DIMENSIONS



DPAK CASE 369C ISSUE C

> NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.245	5.97	6.22
В	0.250	0.265	6.35	6.73
С	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
Е	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.180 BSC		4.58 BSC	
Н	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
К	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.180	0.215	4.57	5.45
S	0.025	0.040	0.63	1.01
U	0.020		0.51	
V	0.035	0.050	0.89	1.27
Z	0.155		3.93	

STYLE 7: PIN 1. GATE

2. COLLECTOR

EMITTER
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